# Product End-of-Life Disassembly Instructions

**Product Category:** Monitors and Displays

**Marketing Name / Model**
[List multiple models if applicable.]

HP Z30i 30-inch IPS Display

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**Purpose:** The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

## 1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.  
1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

<table>
<thead>
<tr>
<th>Item Description</th>
<th>Notes</th>
<th>Quantity of items included in product</th>
</tr>
</thead>
<tbody>
<tr>
<td>Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)</td>
<td>With a surface greater than 10 sq cm USB BD, IF BD, POWER BD, Driver BD</td>
<td>4</td>
</tr>
<tr>
<td>Batteries</td>
<td>All types including standard alkaline and lithium coin or button style batteries</td>
<td>0</td>
</tr>
<tr>
<td>Mercury-containing components</td>
<td>For example, mercury in lamps, display backlights, scanner lamps, switches, batteries</td>
<td>0</td>
</tr>
<tr>
<td>Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm</td>
<td>Includes background illuminated displays with gas discharge lamps Panel</td>
<td>1</td>
</tr>
<tr>
<td>Cathode Ray Tubes (CRT)</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>Capacitors / condensers (Containing PCB/PCT)</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height</td>
<td>Power BD only (C805)</td>
<td>1</td>
</tr>
<tr>
<td>External electrical cables and cords</td>
<td>USB cable, Display cable, DVI cable, Power cord</td>
<td>4</td>
</tr>
<tr>
<td>Gas Discharge Lamps</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>Plastics containing Brominated Flame Retardants</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner</td>
<td>Include the cartridges, print heads, tubes, vent chambers, and service stations.</td>
<td>0</td>
</tr>
<tr>
<td>Components and waste containing asbestos</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>Components, parts and materials containing refractory ceramic fibers</td>
<td>0</td>
<td></td>
</tr>
<tr>
<td>Components, parts and materials containing radioactive substances</td>
<td>0</td>
<td></td>
</tr>
</tbody>
</table>

## 2.0 Tools Required

List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.
### Tool Description

<table>
<thead>
<tr>
<th>Tool Description</th>
<th>Tool Size (if applicable)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Description #1 SCREW DRIVER(PHILLIPS HEAD)</td>
<td>#2</td>
</tr>
<tr>
<td>Description #2 SCREW DRIVER(PHILLIPS HEAD)</td>
<td>#0</td>
</tr>
<tr>
<td>Description #3</td>
<td></td>
</tr>
<tr>
<td>Description #4</td>
<td></td>
</tr>
<tr>
<td>Description #5</td>
<td></td>
</tr>
</tbody>
</table>

### 3.0 Product Disassembly Process

#### 3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Remove Stand Base From Display Head
2. Remove Rear Cover From Display Head
3. Remove Front Cover From Display Head
4. Remove Keyboard Off From Front Cover
5. Disassemble Front Cover ASSY
6. Disassemble Rear Cover ASSY
7. Take Screw(*4) Off From Chassis Cover & Remove Panel
8. Take Screw(x11) Off From P.C.B
9. Take Screw(x11) Off From P.C.B
10. Take Off P.C.B From Chassis & Remove BKT (Printed Circuit Assemblies>10cm**2)
11. Remove Mylar From Chassis Cover
12. Remove Gasket From Chassis Cover
13. LCD PANEL EXPLODE
14. Remove VESA Cover, pivot cover off Stand Base
15. Remove Riser Lift cover off Stand Base
16. Remove Base Cover & Base Cover BKT Off Stand Base
17. Remove Stand Front Cover Off Stand BKT
18. Remove Stand Rear Cover Off Stand Base

#### 3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).
HP Z30i Disassembly Process

- Tonny Hu
- Mechanical Engineer
- May-08-2013
External Electric Cables Dissecting Process

1. Remove Cable From Display Head.

2. Dissecting To Complete.
3. Pull the release button

4. Remove Stand Base From Display Head.
Remove Rear Cover From Display Head

5. Remove four wall mount screws from display head.

6. Remove Rear Cover From Display Head.
Remove Front Cover From Display Head

7. Remove Front Cover.

Remove Connector
7. Take three screws off from front cover

8. Remove keyboard from FC
Disassemble Front Cover ASSY

[Image of the front cover with a red circle highlighting the area to be disassembled.]

- Function key
- Power Button

[Image of the front cover with labels indicating functional areas.]
Disassemble Rear Cover ASSY

8. Remove 4 screws
Take Screw(*4) Off From Chassis Cover & Remove Panel

1. Remove connector from panel.
2. Take Screw(x4) Off from Chassis cover
3. Remove connector off from Panel.
4. Remove the panel.
1. Take Screw(x8) Off From P.C.B

2. Take Screw(x3) Off From USB BD
Take Screw(x11) Off From P.C.B
Take Off P.C.B From Chassis & Remove BKT (Printed Circuit Assemblies > 10cm²)
Remove Mylar From Chassis Cover
Remove Gasket From Chassis Cover
LCD PANEL EXPLODE

Step 1. Loose and remove C/Shield Screw 3ea and remove C/Shield

Step 2. Take C/Top off

Step 3. Take B/Ass’y off

Step 4. Loose and remove B/L Screw 6ea and disassemble LED CNT 2ea
Step 5. Take Guide Panel off

Step 6. Remove Sheets (3ea)

Step 7. Take LGP off

Step 8. Remove Reflector
<table>
<thead>
<tr>
<th>Step 9. Take LED off</th>
</tr>
</thead>
<tbody>
<tr>
<td><img src="image1" alt="Image of LED panel" /></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>Step 10. LED</th>
</tr>
</thead>
<tbody>
<tr>
<td><img src="image2" alt="Image of LED" /></td>
</tr>
</tbody>
</table>
Remove VESA Cover, pivot cover off Stand Base

Take 8 screws off

Take 2 screws off
Remove Riser Lift cover off Stand Base
Remove Base Cover & Base Cover BKT Off Stand Base

- Take 6 Rubbers off
- Take 16 Screws off
Remove Stand Front Cover Off Stand BKT
Remove Stand Rear Cover Off Stand Base

Take 5 Screws off